



目录

电性参数

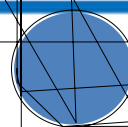
可靠性实验

外形尺寸

包装

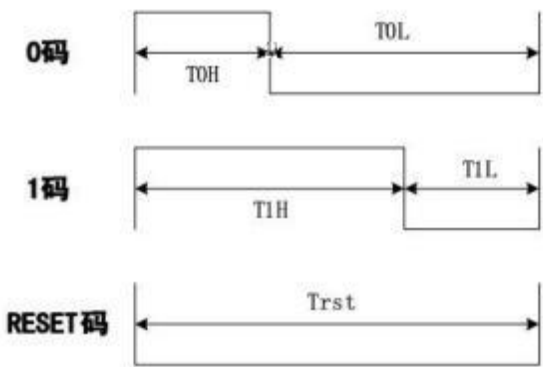
焊接指导

使用注意事项





:Time sequence waveform:

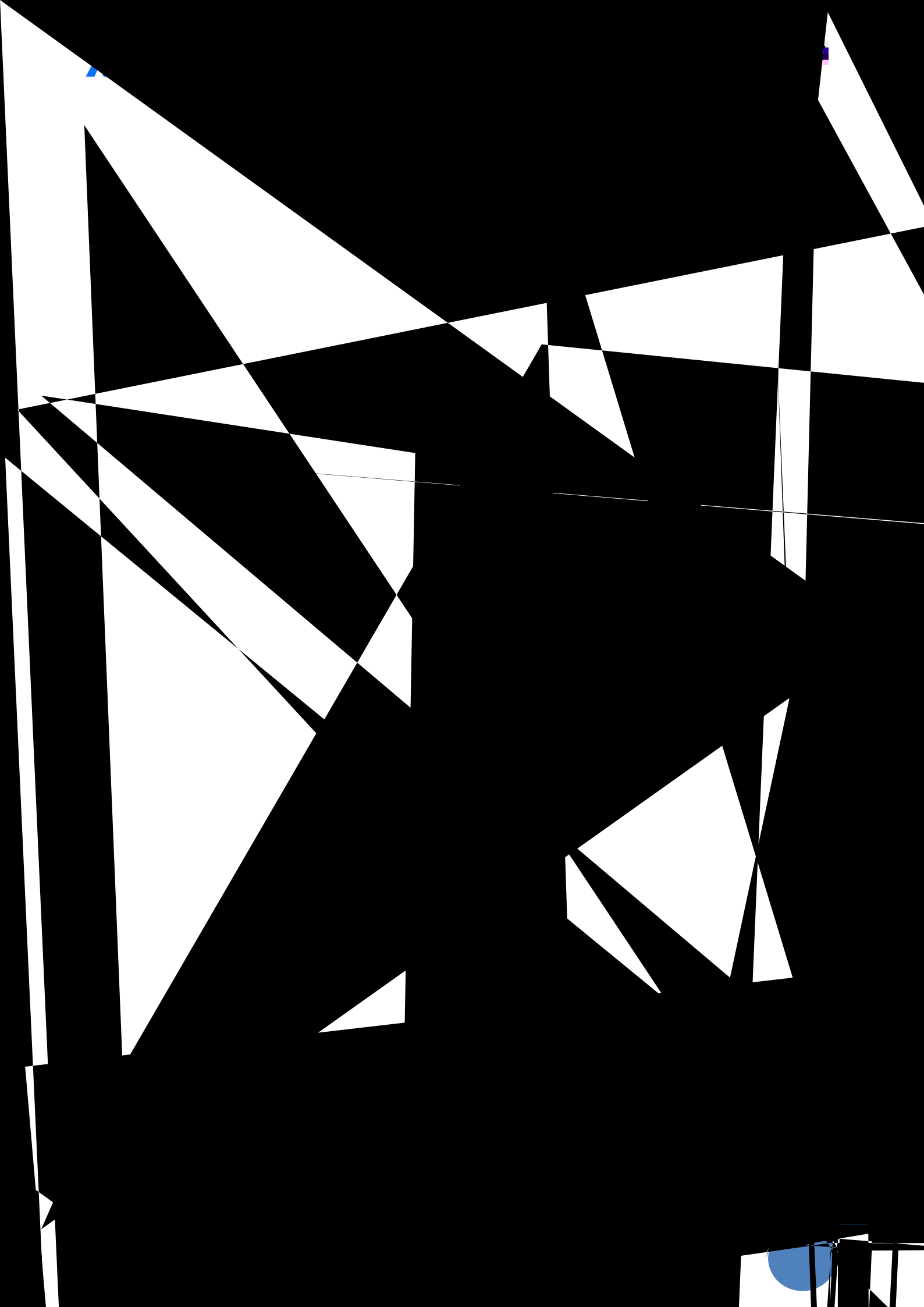


:

0 Input 0 code high level time	Tin0h	-	0.295	-	us
1 Input 1 code high level time	Tin1h	-	0.595	-	us
0 Input 0 code low level time	T0L	-	0.595	-	us
1 Input 1 code low level time	T1L	-	0.295	-	us
0 /1 0 code /1 code cycle	T0/T1	0.89	-	-	us
RESET Reset code low level time	reset	80	-	-	us

/Note:

0.9us	0	1	0	1
15us				







焊接指导 (2)

Guideline for Soldering

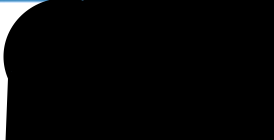
清洗:

* 注意:

PCB

*

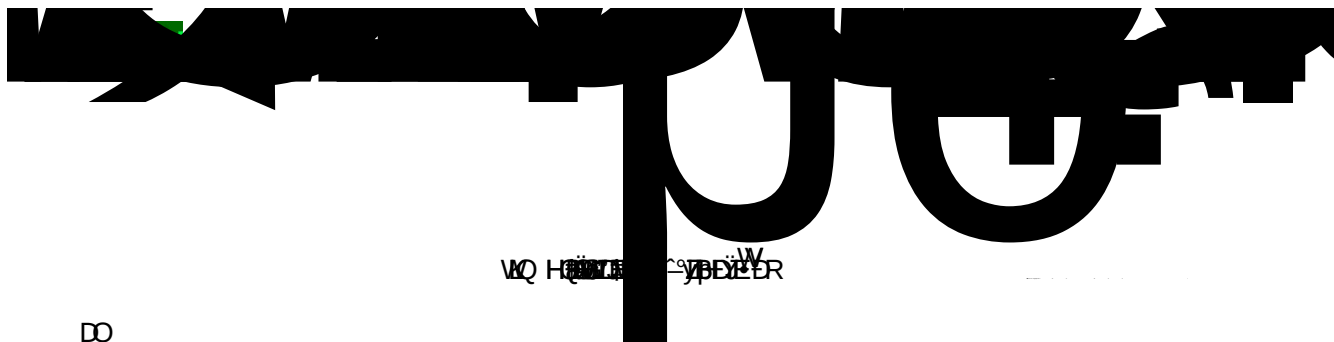
3• f7† "q 6SW"...lww'.x•&•5 x•&•••lyRR •%ˆ!@g%&Q7% FQ7• !xl0†™#1xA % #0 p,R3 €r—) % #V D"8")F%\$C,†™#R8`B qR8ib`P w,Tq" 8U†Gq%)u†&c BD F•RD •RY \$ysAAf, f"€)_AH0 7•\$A`St•1xiff)sV, Byf H „T ˆxXif cx1(\$—Yq% H,





使用注意事项（3）

Precautions (3)



DO